# 3W HI-POWER LED SPECIFICATION

# HPB8b-49K3xWHBx



Drawn by	Checked by	Approved by



DATE:2011/7/23 REV:B



# **HUEY JANN ELECTRONICS INDUSTRY CO., LTD.**

HUEY JANN High Power 3W LED is made of GaInN chips with precise package technique which makes excellent heat dissipation to reach the advantages of high luminous efficiency, low decay, and long endurance. Now we have these colors available: red, green, blue, white, yellow and infrared.

## **FEATERUS**

- Instant light
- Long operating life
- Superior ESD defense
- Low voltage DC operated
- More energy efficient than incandescent and most halogen lamps

#### **TYPICAL APPLICATIONS**

- Architectural detail lighting
- Portable flashlight
- Medical applications
- Beacon lights
- Decoration lights
- Spotlight



## **HUEY JANN ELECTRONICS INDUSTRY CO., LTD.**

# **Explanation of Part Number:**

1.H: Huey Jann 2.P: High power LED Type

4.Identification no: 3. Shape distinguish:

B: Lambertian type S: Side emitting type D: Focusing type E: Focusing type

R: Reflector type

5.Lead frame type 6.Appearance:

> 1:White Diffusion 4:Water Clear

7.Color number: 8.Power type:

3K: Green Non: 1W 4K: Yellow 05: 0.5W 5K: Red 8K: Blue 3: 3W 5: 5W 9K: White

9.Color kind:

10.Heat conduction type: WHBx: Pure White Non: emitter type

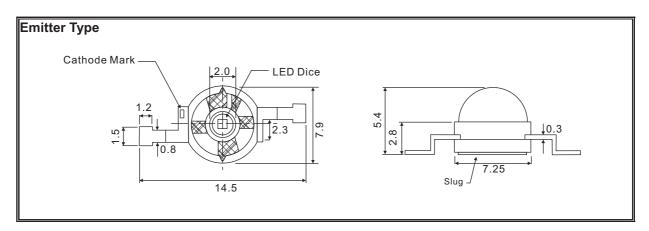
YWHBx(4000°K): Nature White /WPCB: with white star type heat sink

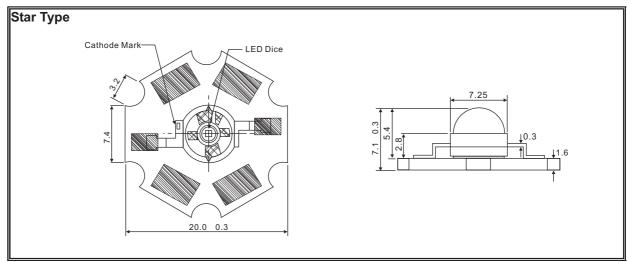
YWHBx: Warm White



## **HUEY JANN ELECTRONICS INDUSTRY CO., LTD.**

#### **PACKAGE DIMENSIONS:**





## NOTE:

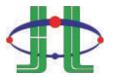
- 1.All dimensions are in millimeter.
- 2.Lead spacing in measured where the lead emerge from the package.
- 3.prodruded resin under flange is 1.5mm max.
- 4.specifications are subject to change without notice.
- 5. Tolerance is 0.3mm unless otherwise noted.
- 6.Driving LED without heat sinking device is forbidden.
- 7. It is strongly recommended that the temperature of lead be not higher than 55°C.
- 8. Proper current derating must be observed to maintain junction temperature below the maximum.
- 9.LEDs are not designed to be driven in reserve bias.



# **HUEY JANN ELECTRONICS INDUSTRY CO., LTD.**

# **DEVICES**

ltem	Lens Color	Dice Source	Color Temperature Typ (°K)
HPB8b-49K3WHB			6000
HPB8b-49K3WHB/WPCB			0000
HPB8b-49K3YWHB(4000°K)			
HPB8b-49K3YWHB/WPCB(4000°K)	RI 90	4000	
HPB8b-49K3YWHB(4000°K)/CRI 90		0 1 1//0 1/	4000
HPB8b-49K3YWHB/WPCB(4000°K)/CRI 90	Water Clear	GalnN/GaN	
HPB8b-49K3YWHB			
HPB8b-49K3YWHB/WPCB			2200
HPB8b-49K3YWHB/CRI 90			3300
HPB8b-49K3YWHB/WPCB/CRI 90			



# **HUEY JANN ELECTRONICS INDUSTRY CO., LTD.**

#### **BABSOLUTE MAXIMUM RATINGS**

TA=25°C

PARAMETER	SYMBOL	MAX. RATING	UNIT				
Continuous Forward Current	IF	700	mA				
Peak Forward Current *1	IFM	1000	mA				
Electrostatic Discharge(HBM)	ESD	4000	V				
LED Junction Temperature	Tj	135	°C				
Operating Temperature	Topr	-40 ~ +110	°C				
Storage Temperature	Tstg	-40 ~ +120	°C				
Manual Soldering Temperature 260 °C for 5 seconds max. *2 *3							

<sup>\*1.</sup>Duty Ratio=0.1%, Pulse Width=10us.

- \*2.Iron soldering high temperature will not cause damage to the dice. But be aware of the high temperature will not only make the epoxy soften but also cause the lead moving and the gold wire broken and even open. So before returning to the normal temperatures PLEASE AVOID any serious pressure on the top of epoxy and lead.
- \*3.Measured at leads, lens temperature must not exceed 120°C during lead soldering and slug attach. Soldering by general IR reflow, Vapor phase reflow and wave soldering on this system product is unsuitable. Selective heating of the leads limit lead soldering, such as by hot bar reflow, fiber focussed IR, or hand soldering. The package back plane (slug) may not be attached by soldering, but rather with a thermally conductive adhesive. Electrical insulation between the slug and the board is necessary. Please consult welding matters needing attention.



# **HUEY JANN ELECTRONICS INDUSTRY CO., LTD.**

# **BELECTRIC-OPTICAL CHARACTERISTICS IN COMMON**

TA=25°C

Parameter	Symbol	Test Condition	Тур	Max	Unit
View Angle of Half Power	201/2		120		deg
Forward Voltage	VF		3.5	3.7	V
Thermal Resistance Junction To Case	R θ <sub>J-C</sub>	IF=700mA	13		°C/W
Thermal Resistance Junction To Case With Star Type Heat Sink	R ⊕ J-C		17		°C/W
Temperature Coefficient Of Forward Voltage	$\triangle V_F / \triangle T$		-2		mV/°C

# **ELECTRIC-OPTICAL CHARACTERISTICS TO BE INDEPENDENT**

IF=700mA TA=25°C

Item	CCT (°K)	Brightness (Im)			
item	Typical				
HPB8b-49K3WHB	6000	75	225		
HPB8b-49K3WHB/WPCB	0000	73	235		
HPB8b-49K3YWHB(4000°K)		72	215		
HPB8b-49K3YWHB/WPCB(4000°K)	4000	12	210		
HPB8b-49K3YWHB(4000°K)/CRI 90		90	175		
HPB8b-49K3YWHB/WPCB(4000°K)/CRI 90		90	175		
HPB8b-49K3YWHB		70	400		
HPB8b-49K3YWHB/WPCB	2200	70	190		
HPB8b-49K3YWHB/CRI 90	3300	00	150		
HPB8b-49K3YWHB/WPCB/CRI 90		90	150		



# **HUEY JANN ELECTRONICS INDUSTRY CO., LTD.**

# **PRELIABILITY TEST**

# Endurance Test

Test Item	Reference Standard	Test Conditions	Result
Operation Life	MIL-STD-750:1026 MIL-STD-883:1005 JIS-C-7021 :B-1	Connect with a power if=700mA  Ta=Under room temperature  Test Time=1,000hrs	0/22
High Temperature High Humidity Storage	MIL-STD-202:103B JIS-C-7021 :B-11	Ta=+85°C 5°C RH=80% ~ 85% Test Time=1,000hrs	0/22
High Temperature Storage	MIL-STD-883:1008 JIS-C-7021 :B-10	High Ta=+120°C 5°C Test Time=1,000hrs	0/22
Low Temperature Storage	JIS-C-7021 :B-12	Low Ta=-40°C 5°C Test Time=1,000hrs	0/22

## \*Failure Criteria:

- 1. VF arise ≥ 10%
- 2. IV decline  $\geq 30\%$
- 3. A failure is an LED that is open or shorted



# **HUEY JANN ELECTRONICS INDUSTRY CO., LTD.**

# **RELIABILITY TEST**

## > Environmental Test

Test Item	Reference Standard	Test Conditions	Result
Temperature	MIL-STD-202:107D MIL-STD-750:1051 MIL-STD-883:1010 JIS-C-7021 :A-4	-40°C ~ +25°C ~ +85°C ~ +25°C 60min 20min 60min 20min Test Time=200cycle	0/22
Thermal Shock	MIL-STD-202:107D MIL-STD-750:1051 MIL-STD-883:1010	-40°C 5°C ~ +110°C 5°C 20min 20min Test Time=200cycle	0/22

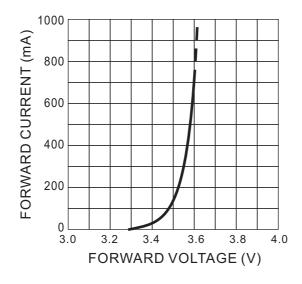
<sup>\*</sup>Failure Criteria:

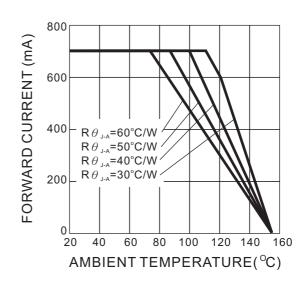
- 1. VF arise ≥ 10%
- 2. IV decline  $\geq 30\%$
- 3. A failure is an LED that is open or shorted

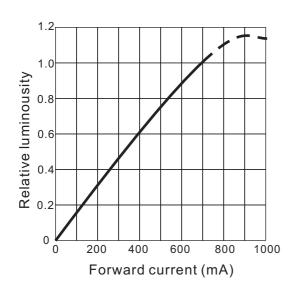


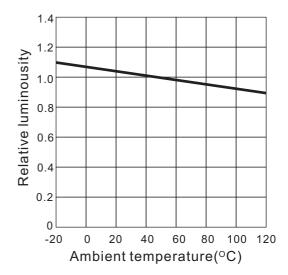
# **HUEY JANN ELECTRONICS INDUSTRY CO., LTD.**

## **TYPICAL ELECTRICAL OPTICAL CHARACTERISTICS CURVES**





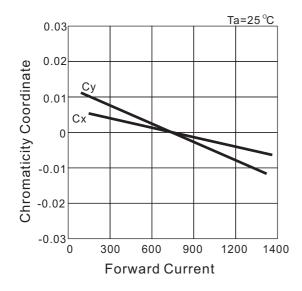


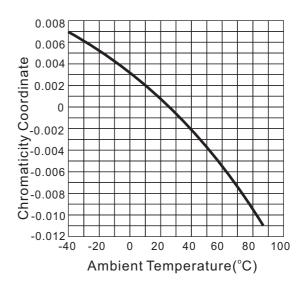


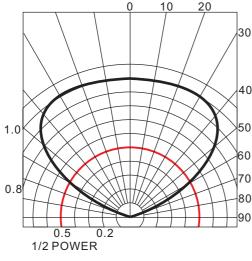


# **HUEY JANN ELECTRONICS INDUSTRY CO., LTD.**

# **TYPICAL ELECTRICAL OPTICAL CHARACTERISTICS CURVES**





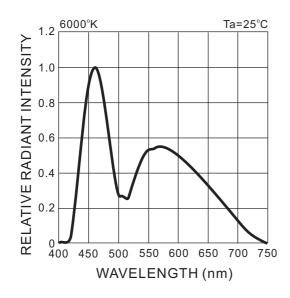


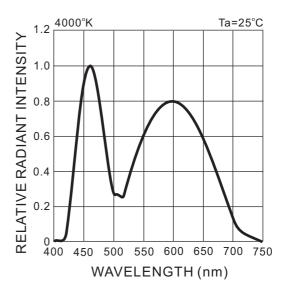
VIEW ANGLE Ta=25 °C

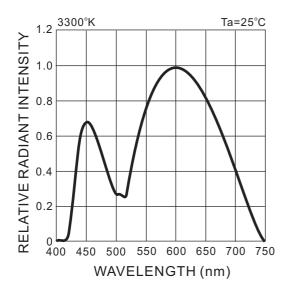


# **HUEY JANN ELECTRONICS INDUSTRY CO., LTD.**

# **TYPICAL ELECTRICAL OPTICAL CHARACTERISTICS CURVES**









# **HUEY JANN ELECTRONICS INDUSTRY CO., LTD.**

# **Brightness Bin Selection**

lione	DIN CODE	Brightness in Im		
Item	BIN CODE	Minimum	Maximum	
HPB8b-49K3WHB	Р	186	240	
THE BOD-49K3WTIB	Q	240	310	
HPB8b-49K3WHB/WPCB	Р	186	240	
INFOOD-49K3W ND/WFCD	Q	240	310	
HPB8b-49K3YWHB(4000°K)	Р	186	240	
HPB8b-49K3YWHB/WPCB(4000°K)	Γ	100	240	
HPB8b-49K3YWHB(4000°K)/CRI 90	N	143	186	
HPB8b-49K3YWHB/WPCB(4000°K)/CRI 90	) IN	143	100	
HPB8b-49K3YWHB	N	143	186	
INFOOD-49K31WIID	Р	186	240	
HPB8b-49K3YWHB/WPCB	N	143	186	
INPOOD-49K31WND/WPCD	Р	186	240	
HPB8b-49K3YWHB/CRI 90	М	110	143	
ILLOON-43V31 MAD/CKI AO	N	143	186	
HPB8b-49K3YWHB/WPCB/CRI 90	М	110	143	
THE DOD-491/3 I WITID/WE CO/CIVI 90	N	143	186	

## NOTE:

1. Test Condition at IF=700mA.



# HUEY JANN ELECTRONICS INDUSTRY CO., LTD.

# Pure White Color Bin Selection

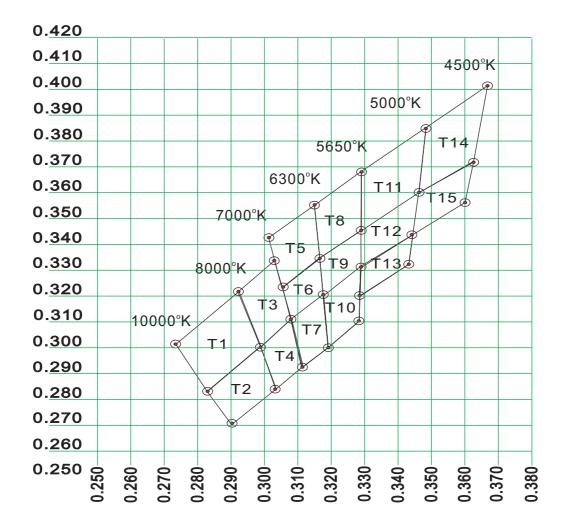
Bin	CCT(°K) TYP	Chromaticity Coordinates				
T4	0000	Х	0.274	0.292	0.299	0.283
T1	9000	У	0.301	0.322	0.300	0.284
TO	0000	Х	0.283	0.299	0.303	0.290
T2	9000	у	0.284	0.300	0.283	0.270
Т3	8000	Х	0.292	0.303	0.308	0.299
13	0000	у	0.322	0.333	0.311	0.300
T4	8000	Х	0.299	0.308	0.311	0.303
14	8000	У	0.300	0.311	0.293	0.283
T5	6700	Х	0.301	0.314	0.316	0.305
15	6700	У	0.342	0.355	0.333	0.322
T6	6700	Х	0.305	0.316	0.317	0.308
10	0700	у	0.322	0.333	0.320	0.311
T7	6700	Х	0.308	0.317	0.319	0.311
17	0700	у	0.311	0.320	0.300	0.293
T8	6000	Х	0.314	0.329	0.329	0.316
10	0000	у	0.355	0.369	0.345	0.333
Т9	6000	Х	0.316	0.329	0.329	0.317
19	0000	у	0.333	0.345	0.331	0.320
T10	6000	Х	0.317	0.329	0.329	0.319
110	0000	у	0.320	0.331	0.310	0.300
T11	5300	Х	0.329	0.348	0.346	0.329
111	3300	у	0.369	0.385	0.359	0.345
T12	5300	Х	0.329	0.346	0.329	0.344
112	3300	у	0.345	0.359	0.331	0.344
T13	5300	Х	0.344	0.329	0.343	0.329
110	3300	у	0.344	0.331	0.331	0.320
T14	4750	Х	0.348	0.367	0.362	0.346
117	7700	у	0.385	0.400	0.372	0.359
T15	4750	Х	0.346	0.362	0.360	0.344
110	4700	У	0.359	0.372	0.357	0.344



# HUEY JANN ELECTRONICS INDUSTRY CO., LTD.

# Pure White Color Bin Selection

## ➤ CIE Light Color Chart





# **HUEY JANN ELECTRONICS INDUSTRY CO., LTD.**

# ■ Nature White Color Bin Selection

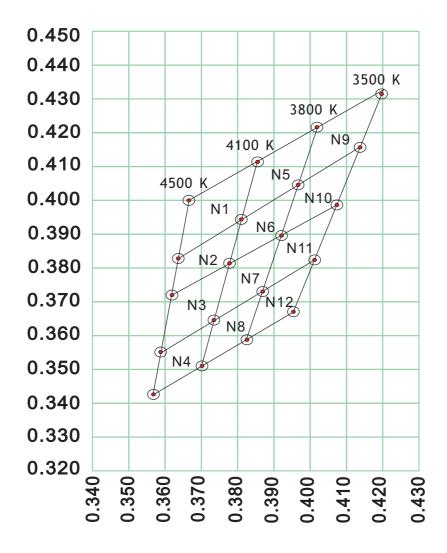
Bin	CCT(°K) TYP	Chromaticity Coordinates				
NIA		Х	0.367	0.385	0.381	0.364
N1	4300	У	0.400	0.412	0.393	0.382
N2	4300	Х	0.364	0.381	0.378	0.362
INZ	4300	У	0.382	0.393	0.382	0.371
N3	4300	Х	0.362	0.378	0.374	0.359
INS	4300	У	0.371	0.382	0.365	0.355
N4	4300	Х	0.359	0.374	0.370	0.357
11/4	4300	У	0.355	0.365	0.351	0.342
N5	3950	Х	0.385	0.402	0.396	0.381
CM	3930	У	0.412	0.422	0.403	0.393
N6	3950	Х	0.381	0.396	0.392	0.378
INO	3950	У	0.393	0.403	0.390	0.382
N7	3950	Х	0.378	0.392	0.387	0.374
INT	3930	У	0.382	0.390	0.373	0.365
N8	3950	Х	0.370	0.387	0.382	0.357
INO	3930	У	0.351	0.373	0.359	0.342
N9	3650	Х	0.402	0.420	0.414	0.396
INS	3030	У	0.422	0.432	0.416	0.403
N10	3650	Х	0.396	0.414	0.408	0.392
INTO	3000	У	0.403	0.416	0.399	0.390
N11	3650	Х	0.392	0.408	0.402	0.387
INII	3030	У	0.390	0.399	0.382	0.373
N12	3650	Х	0.387	0.402	0.396	0.382
INIZ	3030	У	0.373	0.382	0.367	0.359



# HUEY JANN ELECTRONICS INDUSTRY CO., LTD.

# Nature White Color Bin Selection

## ➤ CIE Light Color Chart





# **HUEY JANN ELECTRONICS INDUSTRY CO., LTD.**

# **■ Warm White Color Bin Selection**

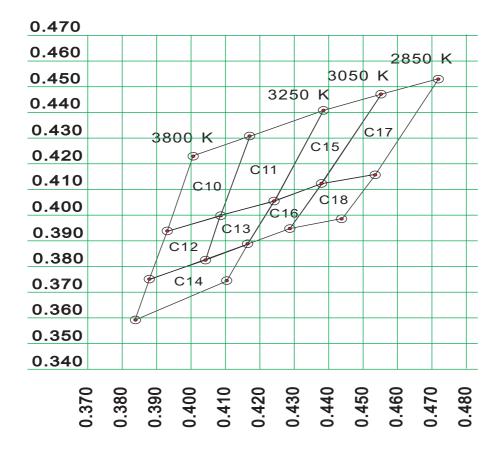
Bin	CCT(°K) TYP	Chromaticity Coordinates				
040		Х	0.402	0.417	0.409	0.392
C10	3640	У	0.423	0.431	0.400	0.391
C11	3500	Х	0.417	0.438	0.424	0.409
CII	3300	У	0.431	0.440	0.406	0.400
C12	3640	Х	0.392	0.409	0.402	0.387
C12	3040	У	0.391	0.400	0.382	0.374
C13	2270	Х	0.409	0.424	0.416	0.402
U13	C13 3370	У	0.400	0.406	0.389	0.382
C14	3500	Х	0.387	0.416	0.410	0.383
C14	3300	У	0.374	0.389	0.374	0.360
C15	3150	Х	0.438	0.454	0.438	0.424
CIS	3130	У	0.440	0.446	0.412	0.406
C16	3150	Х	0.424	0.438	0.429	0.416
C10	3130	У	0.406	0.412	0.394	0.389
C17	2950	Х	0.454	0.471	0.453	0.438
C17	C17 2950	У	0.446	0.451	0.416	0.412
C18	2950	Х	0.438	0.453	0.444	0.429
C10	2930	У	0.412	0.416	0.399	0.394



# HUEY JANN ELECTRONICS INDUSTRY CO., LTD.

# Warm White Color Bin Selection

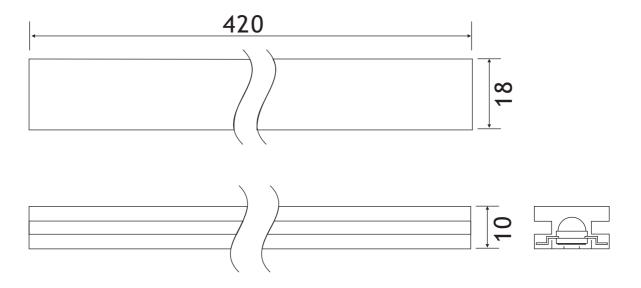
CIE Light Color Chart





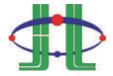
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# Package Dimension For Emitter Type



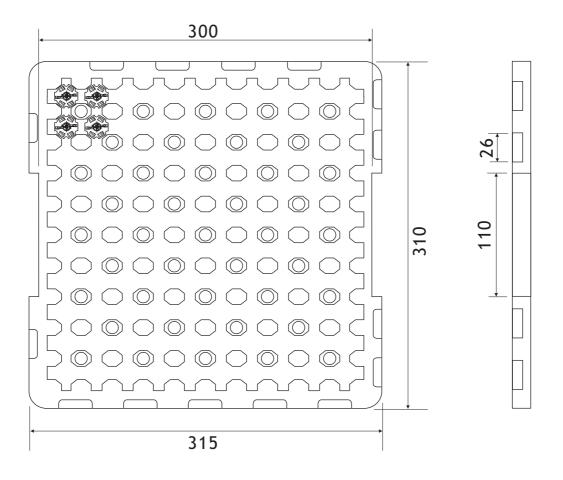
#### NOTE:

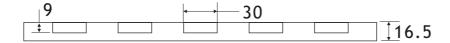
- 1. Dimensions are specified as follows: mm.
- 2. Tolerance is 0.3mm unless otherwise noted.
- 3. 50 pcs emitters per tube.
- 4. 80 tubes per inside box.
- 5. 4 inside box per outside box.



# **HUEY JANN ELECTRONICS INDUSTRY CO., LTD.**

# Package Dimension For Star Type





# NOTE:

- 1. Dimensions are specified as follows: mm.
- 2. Tolerance is 0.3mm unless otherwise noted.
- 3. 100pcs star per tray.
- 4. 10 trays per box.

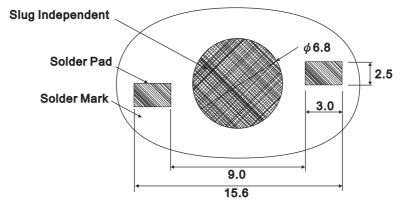


# **HUEY JANN ELECTRONICS INDUSTRY CO., LTD.**

# Requirements to user For Emitter Type

The LED products by HUEY-JANN is designed, manufactured, and sold aiming at high standard quality and reliability, however, reliability of electronic apparatus is seen as a product of reliability superior to HUEY-JANN and using status at users. From this point, HUEY-JANN requests user's for following things.

# Recommended Solder Pad Design For Emitter Type



Note:

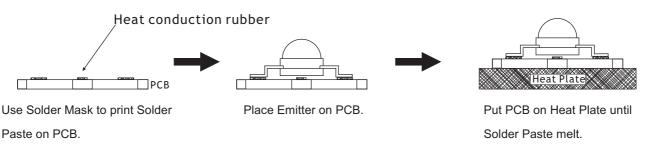
- 1.All dimensions are in millimeters.
- 2. Electrical isolation is required between Slug and Solder Pad.



# **HUEY JANN ELECTRONICS INDUSTRY CO., LTD.**

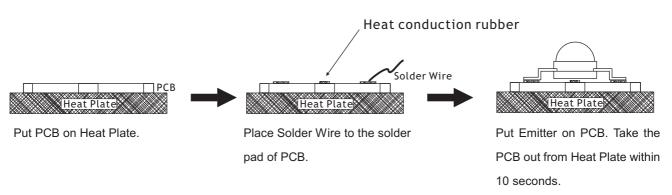
# Heat Plate Soldering Condition For Emitter Type

# a. Soldering Process for Solder Paste



- 1. The Solder Paste sould be melted within 10 seconds.
- 2. Take out PCB out from Heat Plate within 15 seconds.

# b. Soldering Process for Solder Wire



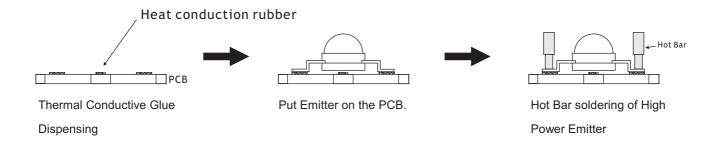
#### NOTE:

- 1.Heat plate temperature: 230°C max for Lead Solder and 260°C max for Lead-Free Solder.
- 2. When soldering, do not put stress on the LEDs during heating.
- 3. After soldering, do not warp the circuit board.



# **HUEY JANN ELECTRONICS INDUSTRY CO., LTD.**

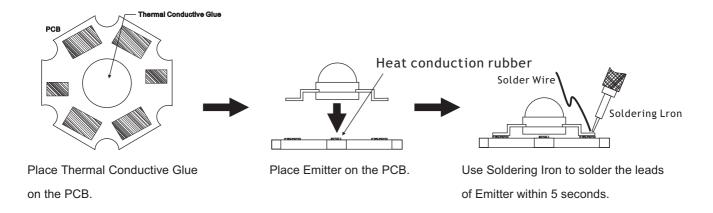
# Soldering Process For Hot Bar For Emitter Type



#### NOTE:

- 1.Hot Bar temperature: 230°C max for Lead Solder and 260°C max for Lead-Free Solder.
- 2. When soldering, do not put stress on the LEDs during heating.
- 3. After soldering, do not warp the circuit board.

# Manual Hand Soldering For Emitter Type



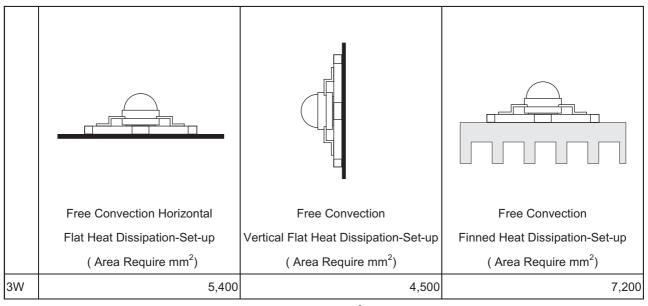
- 1.Solder tip temperature: 230°C max for Lead Solder and 260°C max for Lead-Free Solder.
- 2. Avoiding damage to the emitter or to the PCB dielectric layer. Damage to the epoxy layer can cause
- 3.Do not let the solder contact from solder pad to back-side of PCB. This one will cause a short circuit and damage emitter.



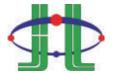
# **HUEY JANN ELECTRONICS INDUSTRY CO., LTD.**

# Conclusion

Huey Jann provide simple comparison table for High Power LED, you could find your request heat dissipation area from the following table.



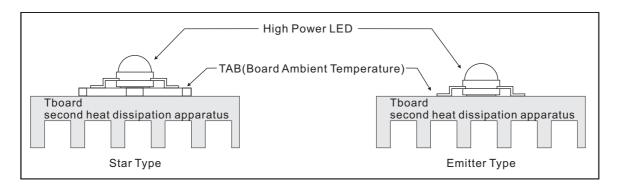
<sup>\*</sup>TAB in this table is according to highest operating temperature 65°C.

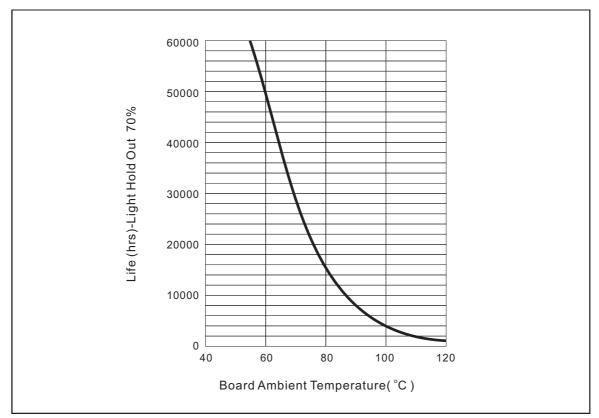


# **HUEY JANN ELECTRONICS INDUSTRY CO., LTD.**

<sup>\*</sup>Different materials of second heat dissipation device, the surface area of heat sink will be different. Thus, this document is for reference only.

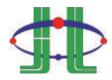
# **TAB Temperature - Life Characteristics Curves**





<sup>\*</sup>Board Ambient Temperature Tolerance 5°C.

<sup>\*</sup>Different materials of second heat dissipation device, the surface area of heat sink will be different. Thus, this document is for reference only.



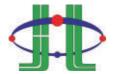
# **HUEY JANN ELECTRONICS INDUSTRY CO., LTD.**

<sup>\*</sup>TAB in this table is according to highest operating temperature 65°C.

<sup>\*</sup>The TAB is the stable testing value for the product lighted 100% after one hour.

#### Remarks:

- 1. Brightness values are measured during a current pulse of typical 25 ms, the brightness tolerance is ±15%.
- 2. Chromaticity coordinates are measured during a current pulse of typical 200 ms, the chromaticity tolerance is ±0.015.
- 3. Forward voltage are measured during a current pulse of typical 5 ms, the VF tolerance is ±0.15V.
- 4. Dimensions are specified as follows: mm.
- 5. Related technical parameters of LED are average value resulted from statistic. The actual parameters of LED could be slightly different from average and characteristic curve.
- 6. The average value of LED will be changed by technical improvement and elevation, and subject to change without prior notice.
- 7. Hi-Power LED can not be operated without second heat dissipating structure.
- 8. Poor or damaged second heat dissipating structure could lead to defective electrical characteristic of High Power LED, CCT escalation, brightness drop, lifetime shortening or burn out. Following instructions of Huey Jann Hi-Power LED series document can avoid LED burn out and electrical defectiveness due to improper usage, and maintain normal performance of the products.



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